As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name; I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention (Design, if applicable) entitled: METHOD FOR CLEANING SEMICONDUCTOR MANUFACTURING SYSTEM

the specification of which (check one):

is attached hereto.

Mas filed on: February 26, 2004

as Application Serial No.: 10/786,118

and (if applicable) was amended on:

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in *Title 37*, *Code of Federal Regulations*, § 1.56. I hereby claim foreign priority benefits under *Title 35*, *United States Code § 119* of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

PRIOR FOREIGN APPLICATION(S)			PRIORITY CLAIMED	
Number	Country	Day/Month/Year Filed	Yes	No
092104123	Taiwan, R.O.C.	February 27, 2003	x	

I hereby claim the benefit under *Title 35*, *United States Code*, § 120 of any United States application(s) or PCT international application(s) designating The United States of America listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in that/those prior application(s) in the manner provided by the first paragraph of *Title 35*, *United States Code*, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in *Title 37*, *Code of Federal Regulations*, § 1.56 which became available between the filing date of the prior application(s) and the national or PCT international filing date of this application:

Application Number	Filing Date	Status - Patented, Pending or Abandonded	
1			

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: I(We) hereby appoint as my(our) attorneys, with full powers of substitution and revocation, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:

Bruce H. Troxell, Reg. No. 26,592

I(We) authorize my(our) attorneys to accept and follow instructions from TAI E INTERNATIONAL PATENT & LAW OFFICE regarding any matter related to the preparation, examination, grant and maintenance of this application, any continuation, continuation-in-part or divisional based thereon, and any patent resulting therefrom, until I(We) or my(our) assigns withdraw this authorization in writing. Send correspondence to: Troxell Law Office PLLC

Telephone Calls to: 703 575 2711

5205 Leesburg Pike

Suite 1404

Falls Church, Virginia 22041

U.S.A.

Full Name of First or Sole Inventor Wei-Sheng CHAO					
Post Office Address 🗷 Same as Residence	Citizenship Taiwan, R.O.C.				
Residence Address 4F-4, No. 35, Lin-Te St., Ling -Ya Dist., Kaohsiung, Taiwan, R.O.C.					
DATE 12/31 03	SIGNATURE Wei-Sleng Chao				
Full Name of Joint Inventor Chi-Hui LIN					
Post Office Address 🗵 Same as Residence	Citizenship Taiwan, R.O.C.				
Residence Address No. 78, Chung-Hsing St., Ling-Ya Dist., Kaohsiung, Taiwan, R.O.C.					
DATE VOMOVI	SIGNATURE Chi Chi				

DECLARATION FOR PATENT APPLICATION AND APPOINTMENT OF ATTORNEY

Page 2

Full Name of Joint Inventor Chuang-I CHEN	Citizenshup Taiwan, R.O.C.			
Raidonce Address No. 65, Chien-Ta-Pu, Tungyuan Village, Tungshan Hsiang, Tainan Hsien, Taiwan, R.O.C.	Post Uffice Address 🛭 Sume as Residence			
DATE 134-07	Chrising I Chen			
Full Name of Joint Inventor Goang-Cheng CHANG	Ciuzenship Taiwan, R.O.C.			
Residence Address 10F-2, No. 11, Lane 39, Min-Chuan 1st Rd., Ling-Ya Dist., Kaohsiung, Taiwan, R.O.C.	Post Office Address D Same as Residence			
Jan. 5/04	SIGNATURE God-chey Chap			
Full Name of Join Inventor Chao-Kai HSIEH	Cuizenship Taiwan, R.O.C.			
Residence Address No. 11, Alley 2, Lane 323, Kungyu St., Pingtung, Taiwan, R.O.C.	Post Office Address 🛛 Same as Residence			
Jan. 6, of	signature Chao-Kai Hsteh			
Full Name of Joint Invotor Hsin-Cheng HUANG	Cinizenship Taiwan, R.O.C.			
Residence Address No. 3-3, Alley 8, Lane 726, Yunung Rd., East Dist., Tainan , Taiwan, R.O.C.	Post Office Address XI Sume as Residence			
Jan. 06/04	SIGNATURE HSIN-Chenz Huang			
8				
Full Name of Joins Inventor Cheng-Jye CHU	Citizenship Taiwan, R.O.C.			
Residence Address 16F, No. 3, Lane 30, Te-Shan St., San-Min Dist., Kaohsiung, Taiwan, R.O.C.	Post Office Address 🛛 Same as Residence			
DATE 17-463	SIGNATURE Office			
Full Name of Joins Inventor	Ciazonship			
Residence Address	Post Office Address Sume as Residence			
DATE	SIGNATURE			